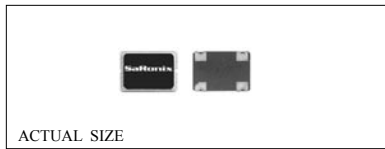


Technical Data

S1613 Series



Description

The S1613 Series crystal-controlled, low-current oscillators provide precise rise and fall times and low output jitter to drive high performance applications. The sub-miniature, low profile leadless ceramic package has gold-plated contact pads, ideal for today's pick-and-place SMT environments.

Applications & Features

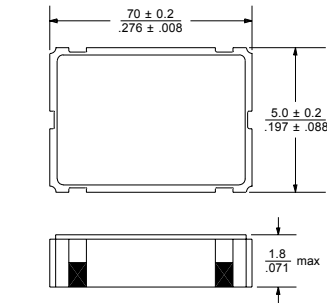
- Low Jitter, tighter stability, compact design
- Fibre Channel - 106.25MHz
- Tight stability, (± 20 ppm all inclusive) ideal for 802.11 applications
- Gigabit Ethernet - 125 MHz
Perfect for PCs; Notebook, Palmtop Computers; Portable Applications; PCMCIA Cards, or anywhere small size, low power, surface mountability are a priority
- Tri-State Standard
- Low-power Stand-by feature
- 1.8mm high ceramic package
- 3.3V operation
- LVCMOS/LVTTL compatible
- Available on tape & reel; 16mm tape, 1000pcs per reel

Frequency Range:		1.544 MHz to 125 MHz
Frequency Stability:		± 20 , ± 25 , ± 50 or ± 100 ppm over all conditions; calibration tolerance, operating temperature, rated input (supply) voltage changes, load change, *aging, shock and vibration.
*Aging:		1 year @ 25°C average ambient operating temperature
Temperature Range:		
Operating:		-10 to +70°C, -40 to +85°C
Storage:		-55 to +125°C
Supply Voltage:		3.3V $\pm 10\%$
Supply Current:		
Output Enabled:		15mA max 1.544 to 32 MHz 25mA max 32+ to 50 MHz 40mA max 50+ to 80 MHz 55mA max 80+ to 125 MHz
Output Disabled:		10 μ A max 1.544 to 125 MHz
Output:		
Symmetry:		45/55 % max @ 50% V _{DD} , -40 to +85°C, 1.544 to 80 MHz 45/55 % max @ 50% V _{DD} , -10 to +70°C, 80 to 125 MHz 40/60 % max @ 50% V _{DD} , -40 to +85°C, 80 to 125 MHz
Rise & Fall Times:		7ns max 1.544 to 50 MHz @ 20% to 80% V _{DD} 5ns max 50+ to 80 MHz 3ns max 80+ to 125 MHz
Logic 0:		10% V _{DD} max
Logic 1:		90% V _{DD} min
Load:		15pF max, 10LSTTL
Jitter 1.544 to 80 MHz:		5ps RMS (1-sigma) max accumulated jitter in 20,000 adjacent periods 1.5ps RMS (1-sigma) max phase jitter in 10kHz - 20MHz freq. band 50ps peak-to-peak max total jitter in 100,000 periods
Jitter 80+ to 125 MHz:		3ps RMS (1-sigma) max accumulated jitter in 20,000 adjacent periods 1ps RMS (1-sigma) max phase jitter in 10kHz - 20MHz freq. band 30ps peak-to-peak max total jitter in 100,000 periods
Tri-State Control Characteristics:		
Output Oscillation (VIN):		≥ 2.2 v or N/C
Output High Impedance:		≤ 0.8 V or GND
Disable Output Delay:		≤ 100 ns
Enable Output Delay:		≤ 10 ms
Internal Pullup Resistance:		≥ 50 k Ω
Mechanical:		
Shock:		MIL-STD-883, Method 2002, Condition B
Solderability:		MIL-STD-883, Method 2003
Vibration:		MIL-STD-883, Method 2007, Condition A
Solvent Resistance:		MIL-STD-202, Method 215
Terminal Strength:		MIL-STD-883, Method 2004, Condition D
Resistance to Soldering Heat:		MIL-STD-202, Method 210, Condition I or J
Environmental:		
Thermal Shock:		MIL-STD-883, Method 1011, Condition A
Moisture Resistance:		MIL-STD-883, Method 1004

Technical Data

S1613 Series

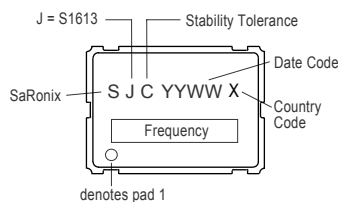
Package Details



Pin Functions:

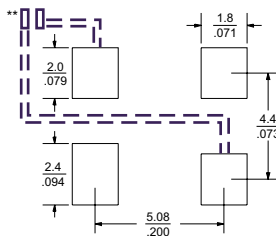
Pin 1: Tri State
Pin 2: GND
Pin 3: Output
Pin 4: VCC

Marking Format*



* Exact location of items may vary

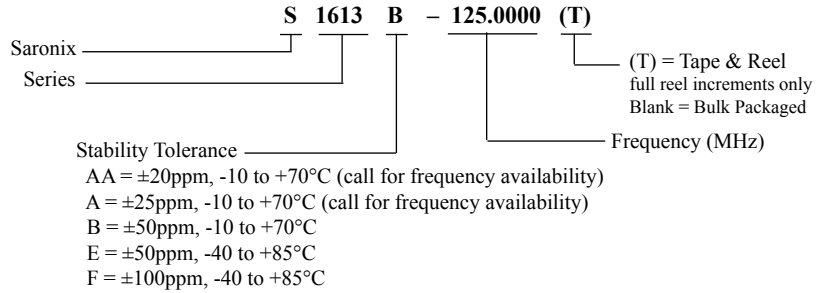
Recommended Land Pattern



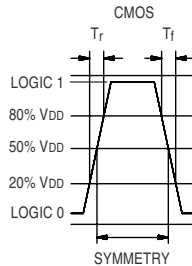
**External power Supply decoupling required

Scale: None (dimensions in mm inches)

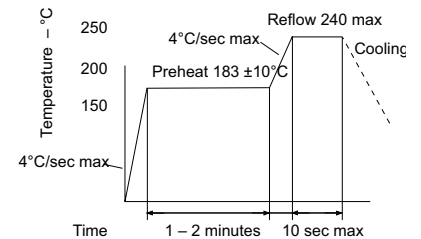
Part Numbering Guide



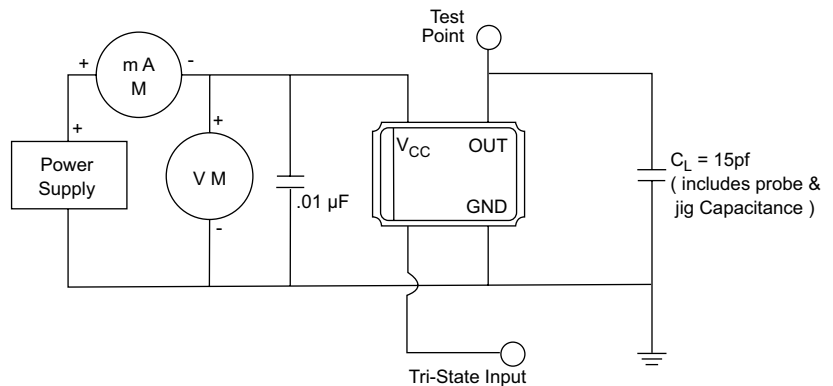
Output Waveform



Solder Reflow Guide



Test Circuits



*All specifications subject to changes without notice